

PATENT ASSIGNMENT COVER SHEET

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 Stylesheet Version v1.2

EPAS ID: PAT4488842

SUBMISSION TYPE:	NEW ASSIGNMENT
NATURE OF CONVEYANCE:	ASSIGNMENT
CONVEYING PARTY DATA	
Name	Execution Date
HSUEH-SHIH CHEN	06/14/2017
PIN-RU CHEN	06/14/2017
RECEIVING PARTY DATA	
Name:	NATIONAL TSING HUA UNIVERSITY
Street Address:	NO. 101, SECTION 2, KUANG-FU ROAD
City:	HSINCHU
State/Country:	TAIWAN
Postal Code:	30013
PROPERTY NUMBERS Total: 1	
Property Type	Number
Application Number:	15625558
CORRESPONDENCE DATA	
Fax Number:	(310)388-5587
<i>Correspondence will be sent to the e-mail address first; if that is unsuccessful, it will be sent using a fax number, if provided; if that is unsuccessful, it will be sent via US Mail.</i>	
Phone:	3109098535
Email:	naquintero@quinterolaw.com
Correspondent Name:	NELSON QUINTERO
Address Line 1:	615 HAMPTON DRIVE SUITE A202
Address Line 4:	VENICE, CALIFORNIA 90291
ATTORNEY DOCKET NUMBER:	10140971
NAME OF SUBMITTER:	NELSON A. QUINTERO
SIGNATURE:	/Nelson A. Quintero/
DATE SIGNED:	07/03/2017
Total Attachments: 1	
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ASSIGNMENT

WHEREAS, Hsueh-Shih CHEN and Pin-Ru CHEN hereafter referred to as ASSIGNOR, has/have invented certain new and useful improvements as described and set forth in the below identified application for United States Letters Patent:

Title: NANOWIRE COMPOSITE STRUCTURE AND METHODS OF FORMING THE SAME, SENSING DEVICE AND METHODS OF FORMING THE SAME AND PROTECTIVE STRUCTURES OF A NANOWIRE

Filed: _____ Serial No. _____
Executed on: 2017/6/14

WHEREAS, National Tsing Hua University of No. 101, Sec. 2, Kuang-Fu Rd., Hsinchu, Taiwan, R. O. C. hereinafter referred to as ASSIGNEE, is desirous of acquiring ASSIGNOR'S interest in the said invention and application and in any U.S. Letters Patent which may be granted on the same;

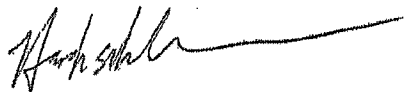
NOW, THEREFORE, TO ALL WHOM IT MAY CONCERN: Be it known that, for good and valuable consideration, receipt of which is hereby acknowledged by Assignor, Assignor has/have sold, assigned and transferred, and by these presents does/do sell, assign and transfer unto the said Assignee, and Assignee's successors and assigns, all his/her/their rights, title and interest in and to the said invention and application and all future improvements thereon, and in and to any Letters Patent which may hereafter be granted on the same in the United States, the said interest to be held and enjoyed by said Assignee as fully and exclusively as it would have been held and enjoyed by said Assignor had this Assignment and transfer not been made, to the full end and term of any Letters Patent which may be granted thereon, or of any division, renewal, continuation in whole or in part, substitution, conversion, reissue, prolongation or extension thereof.

Assignor further agrees/agree that he/she/they will, without charge to said Assignee, but at Assignee's expense, cooperate with Assignee in the prosecution of said application and/or applications, execute, verify, acknowledge and deliver all such further papers, including applications for Letters Patent and for the reissue thereof, and instruments of assignment and transfer thereof, and will perform such other acts as Assignee lawfully may request, to obtain or maintain Letters Patent for said invention and improvement, and to vest title thereto in said Assignee, or Assignee's successors and assigns.

IN TESTIMONY WHEREOF, Assignor has/have signed his/her/their name(s) on the date(s) indicated.

Full name of sole or first inventor: Hsueh-Shih CHEN

Inventor's signature:



Date:

14 Jun 17

Full name of second inventor: Pin-Ru CHEN

Inventor's signature:

Pin-Ru Chen

Date:

2017.06.14